TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC175F, TC74VHC175FT, TC74VHC175FK

Quad D-Type Flip Flop with Clear

The TC74VHC175 is an advanced high speed CMOS QUAD D-TYPE FLIP FLOP fabricated with silicon gate $\rm C^2MOS$ technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These four flip-flops are controlled by a clock input (CK) and a clear input ($\overline{\text{CLR}}$).

The information data applied to the D inputs (D1 thru D4) are transferred to the outputs (Q1 thru Q4 and $\overline{Q}1$ thru $\overline{Q}4$) on the positive-going edge of the clock pulse.

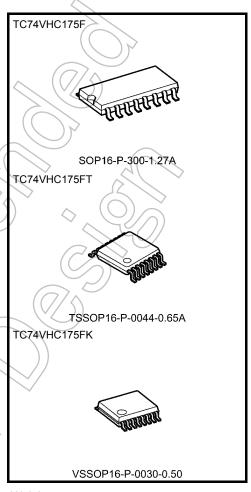
When the \overline{CLR} input is held low, the Q outputs are at the low logic level and the \overline{Q} outputs are at the high logic level, regardless of other input conditions.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High speed: $f_{max} = 210 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{A} = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: $V_{CC \text{ (opr)}} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS175





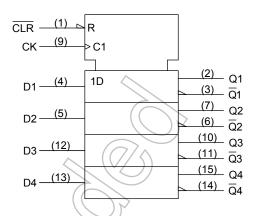
Weight

SOP16-P-300-1.27A : 0.18 g (typ.) TSSOP16-P-0044-0.65A : 0.06 g (typ.) VSSOP16-P-0030-0.50 : 0.02 g (typ.)

Pin Assignment

$\overline{\text{CLR}}$ 1 16 V_{CC} Q1 2 15 Q4 Q1 $\overline{\mathbb{Q}}4$ 3 14 D1 4 13 D4 D2 5 D3 12 Q2 $\overline{Q}3$ 6 11 Q2 10 Q3 GND 8 9 CK (top view)

IEC Logic Symbol

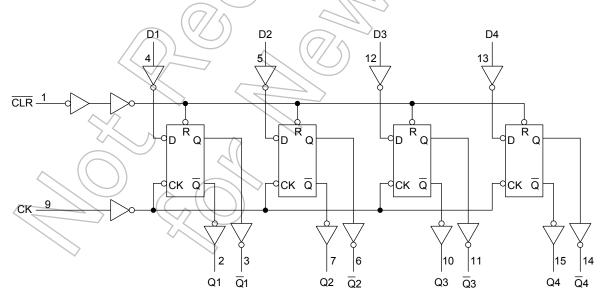


Truth Table

Inputs			Out	puts	Function		
CLR	D	CK	Q	Q	Function		
L	Х	Х	L	Н	Clear		
Н	L		L	Н	_		
Н	Н		Н	L	_ <		
Н	Х	ightharpoons	Qn	\overline{Q}_n	No Change		

X: Don't care

System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50)) mA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Range (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2.0 to 5.5	V
Input voltage	((VIN))	0 to 5.5	V
Output voltage	Vout	0 to VCC	V
Operating temperature	Topr	-40 to 85	°C
Input rise and fall time	dt/dv <	0 to 100 ($V_{CC} = 3.3 \pm 0.3 \text{ V}$) 0 to 20 ($V_{CC} = 5 \pm 0.5 \text{ V}$)	ns/V

Note: The operating range must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit	
			V _{CC} (V)	Min	Тур.	Max	Min	Max			
High-level input		_		2.0	1.50	_ <	/_	1.50	_		
voltage	V _{IH}			3.0 to 5.5	V _{CC} × 0.7	_		V _{CC} × 0.7	_	V	
Low-level input					_	76	0.50	ジ ー	0.50		
voltage		_		3.0 to 5.5	\leftarrow	((/	V _{CC} × 0.3	_	V _{CC} × 0.3	V	
	V _{OH}	V _{IN} = V _{IH} or V _{IL}		2.0	1.9	2.0		1.9	_		
			I _{OH} = -50 μA	3.0	2.9	3.0	_	2.9	_	٧	
High-level output voltage				4.5	4.4	4.5	_	4.4	1		
			$I_{OH} = -4 \text{ mA}$	3.0	2.58	\	_	2.48	<i>/</i>		
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	-6	3.80	> -		
			I _{OL} = 50 μA	2.0)	0.0	0.1	2)/5	0.1		
				3.0	_	0.0	0.1	4	0.1		
Low-level output voltage	V _{OL}			4.5	_	0.0	0.1	> _	0.1	V	
			I _{OL} = 4 mA	3.0	_	_	0.36	_	0.44		
			$I_{OL} = 8 \text{ mA}$	4.5	_	(7)	0.36	_	0.44		
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5			±0.1	_	±1.0	μΑ	
Quiescent supply current	Icc	V _{IN} = V _{CC} or	GND	5.5	_))–	4.0	_	40.0	μA	

Timing Requirements (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta =	25°C	Ta = -40 to 85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width	t _{w (L)}	$\langle \langle \langle \langle \rangle \rangle \rangle$	3.3 ± 0.3	_	5.0	5.0	ns
(CK)	t _{w (H)}		5.0 ± 0.5	_	5.0	5.0	115
Minimum pulse width	+		3.3 ± 0.3	_	5.0	5.0	ns
(CLR)	t _{w (L)}	_	5.0 ± 0.5	_	5.0	5.0	115
Minimum set-up time	. >		3.3 ± 0.3	_	5.0	5.0	ns
Willimitati Set-up time	ts	1	5.0 ± 0.5	-	4.0	4.0	110
Minimum hold time			3.3 ± 0.3	_	1.0	1.0	ns
Will ill full till to the	(th	_	5.0 ± 0.5	_	1.0	1.0	115
Minimum removal time			3.3 ± 0.3	_	5.0	5.0	no
(CLR)	trem	1	5.0 ± 0.5	_	5.0	5.0	ns



AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Tes	t Condition		Ta = 25°C			Ta = - 85	Unit	
	•		V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	
			3.3 ± 0.3	15	_	7.5	11.5	1.0	13.5	ns
Propagation delay time	t_{pLH}			50	_	10.0	15.0	1.0	17.0	
(CK-Q, \overline{Q})	t_{pHL}	_	5.0 ± 0.5	15	_	4.8	7.3	1.0	8.5	
			5.0 ± 0.5	50	_	6.3	9.3	1.0	10.5	
Propagation delay time (CLR -Q, Q)		_	3.3 ± 0.3	15	_	6.3	10.1	/1.0	12.0	- ns
	t _{pLH} t _{pHL}			50	7	8.8	13.6	1.0	15.5	
			5.0 ± 0.5	15	-	4.3	6.4	1.0	7.5	
				50	-((5.8	8.4	1.0	9.5	
	f _{max}	_	3.3 ± 0.3	15	90	140	_	75	1	- MHz
Maximum clock				50 <	50	75	_	45	//	
frequency			5.0 ± 0.5	15	150	210	- (125	> /	
				50 (//	85	115	-((75		
Output to output skew	t _{osLH}	(Note 1)	3.3 ± 0.3	50		-	(1.5	(4)	1.5	ns
Output to output skew	t _{osHL}	(Note 1)	5.0 ± 0.5	50	_	-/	1.0		1.0	113
Input capacitance	C _{IN}		- 4(_	4	(10)	_	10	pF
Power dissipation capacitance	C _{PD}			(Note 2)	_	44/		_	_	pF

Note 1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|$

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 4 \text{ (per bit)}$$

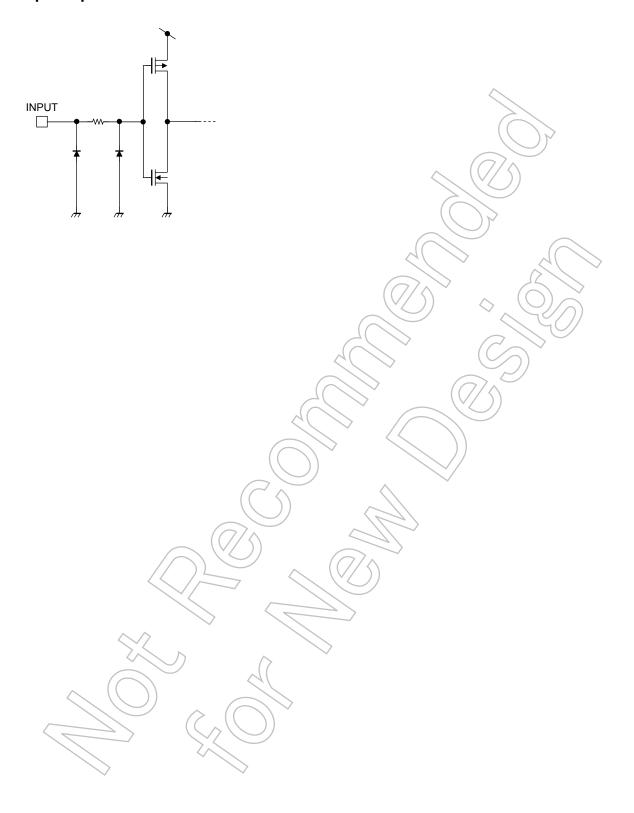
And the total CPD when n pcs.of flip flop operate can be gained by the following equation:

C_{PD} (total) = 30 + 14·n

Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta =	Ta = 25°C	
Characteristics	Symbol	~	V _{CC} (V)	Тур.	Max	Unit
Quiet output maximum dynamic V _{OL}	VOLP	C _L = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic V _{OL}	VOFA	C _L = 50 pF	5.0	-0.4	-0.8	V
Minimum high level dynamic input voltage	V IHD	C _L = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V_{ILD}	C _L = 50 pF	5.0	_	1.5	٧

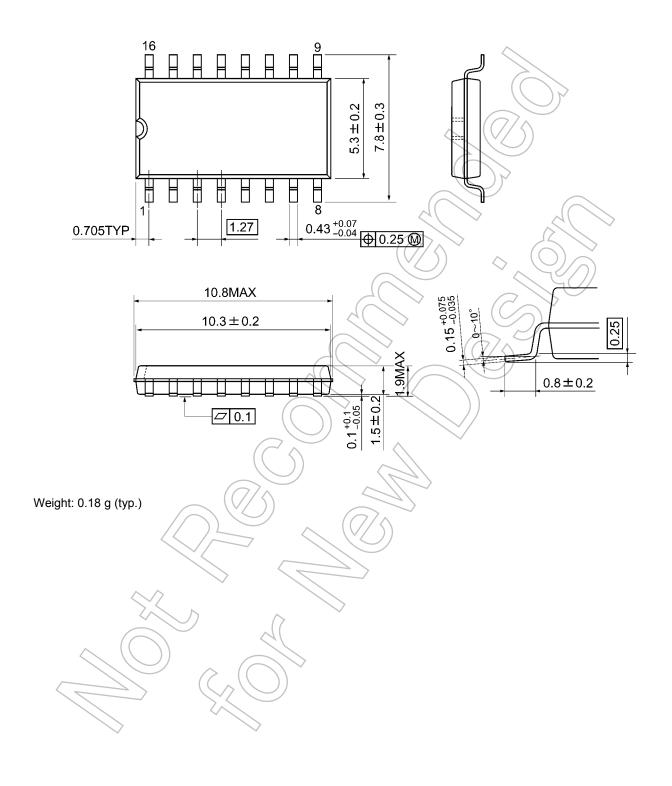
Input Equivalent Circuit





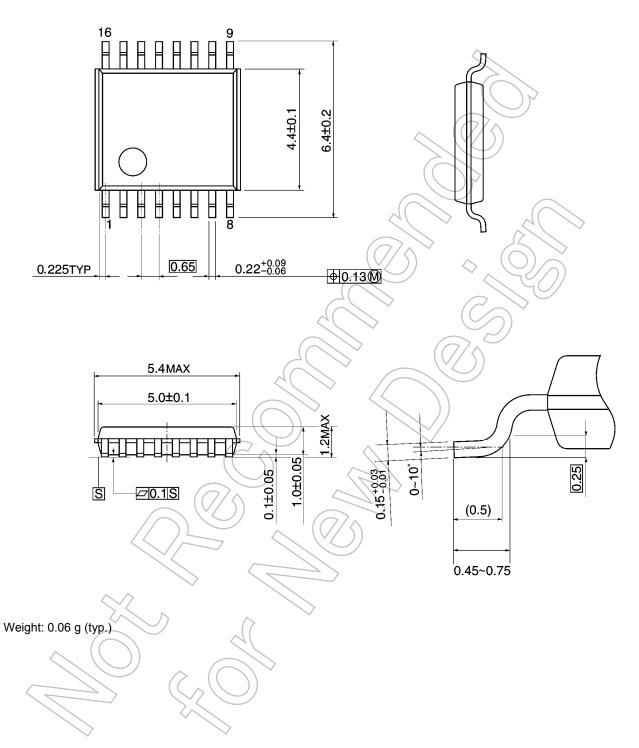
Package Dimensions

SOP16-P-300-1.27A Unit: mm



Package Dimensions

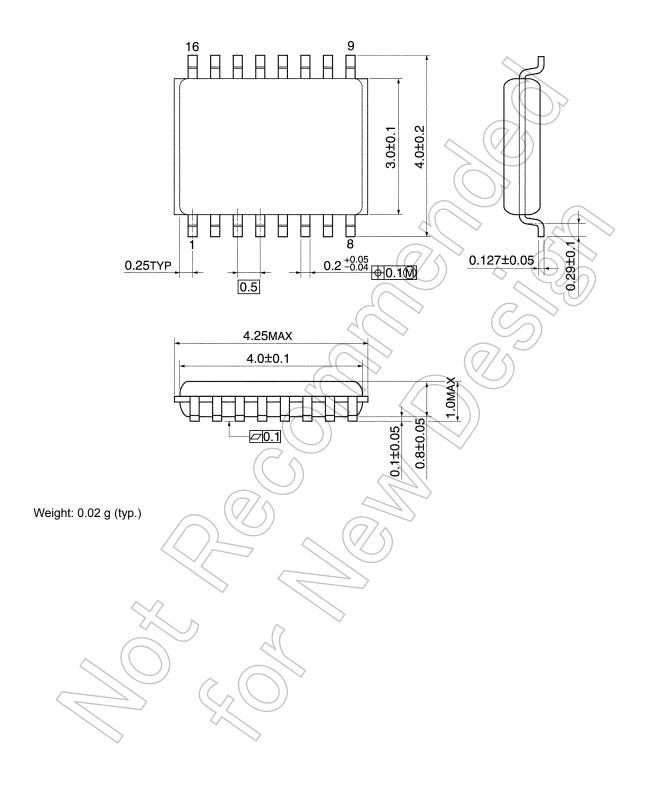
TSSOP16-P-0044-0.65A Unit: mm





Package Dimensions

VSSOP16-P-0030-0.50 Unit: mm



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